

## Single and Dual Single Supply Ultra-Low Noise, Ultra-Low Distortion, Rail-to-Rail Output, Op Amp

The ISL28190 and ISL28290 are tiny single and dual ultra-low noise, ultra-low distortion operational amplifiers. Fully specified to operated down to +3V single supply. These amplifiers have outputs that swing rail-to-rail, and an input common mode voltage that extends below ground (ground sensing).

The ISL28190 and ISL28290 are unity gain stable with an input referred voltage noise of  $1\text{nV}/\sqrt{\text{Hz}}$ . Both parts feature 0.00017% THD+N @ 1kHz.

The ISL28190 is available in the space-saving 6 Ld  $\mu\text{TDFN}$  (1.6mmx1.6mm) and 6 Ld SOT-23 packages. The ISL28290 is available in the 10 Ld  $\mu\text{TQFN}$  (1.8mmx1.4mm) and 10 Ld MSOP packages. All devices are guaranteed over  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

## Ordering Information

| PART NUMBER               | PART MARKING     | PACKAGE (Pb-free)      | PKG. DWG. #  |
|---------------------------|------------------|------------------------|--------------|
| ISL28190FHZ-T7* (Note 1)  | GABH             | 6 Ld SOT-23            | MDP0038      |
| ISL28190FRUZ-T7* (Note 2) | M7               | 6 Ld $\mu\text{TDFN}$  | L6.1.6x1.6A  |
| ISL28290FUZ (Note 1)      | 8290Z            | 10 Ld MSOP             | MDP0043      |
| ISL28290FUZ-T7* (Note 1)  | 8290Z            | 10 Ld MSOP             | MDP0043      |
| ISL28290FRUZ-T7* (Note 2) | E                | 10 Ld $\mu\text{TQFN}$ | L10.1.8x1.4A |
| ISL28290FBZ (Note 1)      | 28290 FBZ        | 8 Ld SOIC              | MDP0027      |
| ISL28290FBZ-T7* (Note 1)  | 28290 FBZ        | 8 Ld SOIC              | MDP0027      |
| ISL28290EVAL1Z            | Evaluation Board |                        |              |

\*Please refer to TB347 for details on reel specifications.

### NOTES:

1. These Intersil Pb-free plastic packaged products employ special Pb-free material sets, molding compounds/die attach materials, and 100% matte tin plate plus anneal (e3 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations). Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.
2. These Intersil Pb-free plastic packaged products employ special Pb-free material sets; molding compounds/die attach materials and NiPdAu plate - e4 termination finish, which is RoHS compliant and compatible with both SnPb and Pb-free soldering operations. Intersil Pb-free products are MSL classified at Pb-free peak reflow temperatures that meet or exceed the Pb-free requirements of IPC/JEDEC J STD-020.

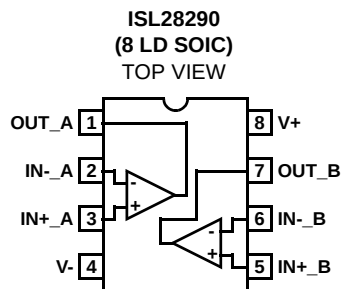
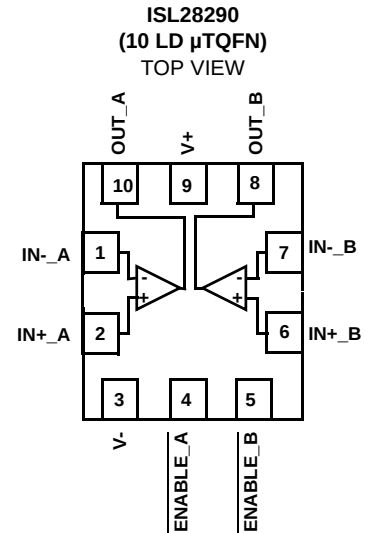
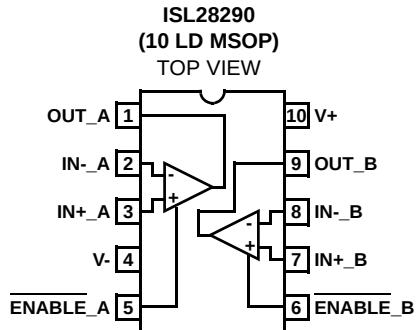
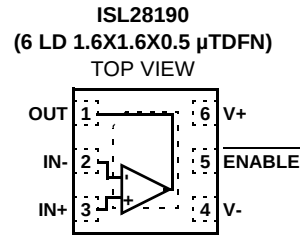
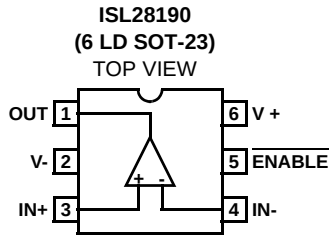
## Features

- $1\text{nV}/\sqrt{\text{Hz}}$  input voltage noise
- 1kHz THD+N typical 0.00017% at  $2V_{P-P}$   $V_{OUT}$
- Harmonic Distortion -87dBc, -90dBc,  $f_o = 1\text{MHz}$
- 170MHz -3dB bandwidth
- $50\text{V}/\mu\text{s}$  slew rate
- 700 $\mu\text{V}$  maximum offset voltage
- 10 $\mu\text{A}$  typical input bias current
- 103dB typical CMRR
- 3V to 5.5V single supply voltage range
- Rail-to-rail output
- Ground sensing
- Enable pin (not available in the 8 Ld SOIC package option)
- Pb-free (RoHS compliant)

## Applications

- Low noise signal processing
- Low noise microphones/preamplifiers
- ADC buffers
- DAC output amplifiers
- Digital scales
- Strain gauges/sensor amplifiers
- Radio systems
- Portable equipment
- Infrared detectors

## Pinouts



**Absolute Maximum Ratings** ( $T_A = +25^\circ\text{C}$ )

|                                  |                        |
|----------------------------------|------------------------|
| Supply Voltage                   | 5.5V                   |
| Supply Turn On Voltage Slew Rate | 1V/ $\mu\text{s}$      |
| Differential Input Current       | 5mA                    |
| Differential Input Voltage       | 0.5V                   |
| Input Voltage                    | V- - 0.5V to V+ + 0.5V |
| ESD Tolerance                    |                        |
| Human Body Model                 | 3kV                    |
| Machine Model                    | 300V                   |
| Charged Device Model             | 1200V                  |

**Thermal Information**

|                                      |                                                                                                                                   |
|--------------------------------------|-----------------------------------------------------------------------------------------------------------------------------------|
| Thermal Resistance (typical, Note 3) | $\theta_{JA}$ ( $^\circ\text{C/W}$ )                                                                                              |
| 6 Ld SOT-23 Package                  | 230                                                                                                                               |
| 6 Ld $\mu\text{TDFN}$ Package        | 125                                                                                                                               |
| 10 Ld MSOP Package                   | 150                                                                                                                               |
| 10 Ld $\mu\text{TQFN}$ Package       | 180                                                                                                                               |
| 8 Ld SOIC Package                    | 125                                                                                                                               |
| Ambient Operating Temperature Range  | -40 $^\circ\text{C}$ to +125 $^\circ\text{C}$                                                                                     |
| Storage Temperature Range            | -65 $^\circ\text{C}$ to +150 $^\circ\text{C}$                                                                                     |
| Operating Junction Temperature       | +125 $^\circ\text{C}$                                                                                                             |
| Pb-free Reflow Profile               | see link below<br><a href="http://www.intersil.com/pbfree/Pb-FreeReflow.asp">http://www.intersil.com/pbfree/Pb-FreeReflow.asp</a> |

**CAUTION:** Do not operate at or near the maximum ratings listed for extended periods of time. Exposure to such conditions may adversely impact product reliability and result in failures not covered by warranty.

**NOTE:**

3.  $\theta_{JA}$  is measured with the component mounted on a high effective thermal conductivity test board in free air. See Tech Brief TB379 for details.

**IMPORTANT NOTE:** All parameters having Min/Max specifications are guaranteed. Typical values are for information purposes only. Unless otherwise noted, all tests are at the specified temperature and are pulsed tests, therefore:  $T_J = T_C = T_A$

**Electrical Specifications** V+ = 5.0V, V- = GND,  $R_L = \text{Open}$ ,  $R_F = 1\text{k}\Omega$ ,  $A_V = -1$  unless otherwise specified. Parameters are per amplifier. Typical values are at V+ = 5V,  $T_A = +25^\circ\text{C}$ . **Boldface limits apply over the operating temperature range, -40 $^\circ\text{C}$  to +125 $^\circ\text{C}$ , temperature data established by characterization.**

| PARAMETER                        | DESCRIPTION                         | CONDITIONS                                         | MIN<br>(Note 4)     | TYP  | MAX<br>(Note 4)   | UNIT                         |
|----------------------------------|-------------------------------------|----------------------------------------------------|---------------------|------|-------------------|------------------------------|
| <b>DC SPECIFICATIONS</b>         |                                     |                                                    |                     |      |                   |                              |
| $V_{OS}$                         | Input Offset Voltage                |                                                    | -1100               | 240  | 700<br><b>900</b> | $\mu\text{V}$                |
| $\frac{\Delta V_{OS}}{\Delta T}$ | Input Offset Drift vs Temperature   | See Figure 21                                      |                     | 1.9  |                   | $\mu\text{V}/^\circ\text{C}$ |
| $I_{IO}$                         | Input Offset Current                |                                                    |                     | 40   | 500<br><b>900</b> | nA                           |
| $I_B$                            | Input Bias Current                  |                                                    |                     | 10   | 16<br><b>18</b>   | $\mu\text{A}$                |
| $V_{CM}$                         | Common-Mode Voltage Range           |                                                    | <b>0</b>            |      | <b>3.8</b>        | V                            |
| CMRR                             | Common-Mode Rejection Ratio         | $V_{CM} = 0\text{V}$ to 3.8V                       | 78                  | 103  |                   | dB                           |
| PSRR                             | Power Supply Rejection Ratio        | $V_S = 3\text{V}$ to 5V                            | 74                  | 80   |                   | dB                           |
| $A_{VOL}$                        | Large Signal Voltage Gain           | $V_O = 0.5\text{V}$ to 4V, $R_L = 1\text{k}\Omega$ | 94<br><b>90</b>     | 102  |                   | dB                           |
| $V_{OUT}$                        | Maximum Output Voltage Swing        | Output low, $R_L = 1\text{k}\Omega$                |                     | 20   | 50<br><b>80</b>   | mV                           |
|                                  |                                     | Output high, $R_L = 1\text{k}\Omega$ , V+ = 5V     | 4.95<br><b>4.92</b> | 4.97 |                   | V                            |
| $I_{S,ON}$                       | Supply Current per Channel, Enabled |                                                    |                     | 8.5  | 11<br><b>13</b>   | mA                           |
| $I_{S,OFF}$                      | Supply Current, Disabled            |                                                    |                     | 26   | 35<br><b>52</b>   | $\mu\text{A}$                |
| $I_{O+}$                         | Short-Circuit Output Current        | $R_L = 10\Omega$                                   | 95<br><b>90</b>     | 144  |                   | mA                           |
| $I_{O-}$                         | Short-Circuit Output Current        | $R_L = 10\Omega$                                   | 95<br><b>90</b>     | 135  |                   | mA                           |
| $V_{SUPPLY}$                     | Supply Operating Range              | V+ to V-                                           | <b>3</b>            |      | <b>5.5</b>        | V                            |
| $\overline{V_{ENH}}$             | $\overline{EN}$ High Level          | Referred to V-                                     | <b>2</b>            |      |                   | V                            |

**Electrical Specifications**  $V_+ = 5.0V$ ,  $V_- = GND$ ,  $R_L = \text{Open}$ ,  $R_F = 1k\Omega$ ,  $A_V = -1$  unless otherwise specified. Parameters are per amplifier. Typical values are at  $V_+ = 5V$ ,  $T_A = +25^\circ C$ . **Boldface limits apply over the operating temperature range,  $-40^\circ C$  to  $+125^\circ C$ , temperature data established by characterization. (Continued)**

| PARAMETER                       | DESCRIPTION                                                                  | CONDITIONS                                                                                                                  | MIN<br>(Note 4) | TYP     | MAX<br>(Note 4)   | UNIT            |
|---------------------------------|------------------------------------------------------------------------------|-----------------------------------------------------------------------------------------------------------------------------|-----------------|---------|-------------------|-----------------|
| $V_{ENL}$                       | $\overline{EN}$ Low Level                                                    | Referred to $V_-$                                                                                                           |                 |         | <b>0.8</b>        | V               |
| $I_{ENH}$                       | $\overline{EN}$ Pin Input High Current                                       | $V_{EN} = V_+$                                                                                                              |                 | 0.8     | 1.2<br><b>1.4</b> | $\mu A$         |
| $I_{ENL}$                       | $\overline{EN}$ Pin Input Low Current                                        | $V_{EN} = V_-$                                                                                                              |                 | 20      | 80<br><b>100</b>  | nA              |
| <b>AC SPECIFICATIONS</b>        |                                                                              |                                                                                                                             |                 |         |                   |                 |
| GBW                             | -3dB Unity Gain Bandwidth                                                    | $R_F = 0\Omega$ , $C_L = 20pF$ , $A_V = 1$ , $R_L = 10k\Omega$                                                              |                 | 170     |                   | MHz             |
| THD+N                           | Total Harmonic Distortion + Noise                                            | $f = 1kHz$ , $V_{OUT} = 2V_{P-P}$ , $A_V = +1$ , $R_L = 10k\Omega$                                                          |                 | 0.00017 |                   | %               |
| HD<br>(1MHz)                    | 2nd Harmonic Distortion                                                      | $V_{OUT} = 2V_{P-P}$ , $A_V = 1$                                                                                            |                 | -87     |                   | dBc             |
|                                 | 3rd Harmonic Distortion                                                      |                                                                                                                             |                 | -90     |                   | dBc             |
| ISO                             | Off-state Isolation<br>$f_O = 100kHz$                                        | $A_V = +1$ ; $V_{IN} = 100mV_{P-P}$ ; $R_F = 0\Omega$ , $C_L = 20pF$ ,<br>$A_V = 1$ , $R_L = 10k\Omega$                     |                 | -38     |                   | dB              |
| X-TALK<br>ISL28290              | Channel-to-Channel Crosstalk<br>$f_O = 100kHz$                               | $V_S = \pm 2.5V$ ; $A_V = +1$ ; $V_{IN} = 1V_{P-P}$ , $R_F = 0\Omega$ ,<br>$C_L = 20pF$ , $A_V = 1$ , $R_L = 10k\Omega$     |                 | -105    |                   | dB              |
| PSRR                            | Power Supply Rejection Ratio<br>$f_O = 100kHz$                               | $V_S = \pm 2.5V$ ; $A_V = +1$ ; $V_{SOURCE} = 1V_{P-P}$ , $R_F = 0\Omega$ ,<br>$C_L = 20pF$ , $A_V = 1$ , $R_L = 10k\Omega$ |                 | -70     |                   | dB              |
| CMRR                            | Common Mode Rejection Ratio<br>$f_O = 100kHz$                                | $V_S = \pm 2.5V$ ; $A_V = +1$ ; $V_{CM} = 1V_{P-P}$ , $R_F = 0\Omega$ ,<br>$C_L = 20pF$ , $A_V = 1$ , $R_L = 10k\Omega$     |                 | -65     |                   | dB              |
| $e_n$                           | Input Referred Voltage Noise                                                 | $f_O = 1kHz$                                                                                                                |                 | 1       |                   | nV/ $\sqrt{Hz}$ |
| $i_n$                           | Input Referred Current Noise                                                 | $f_O = 10kHz$                                                                                                               |                 | 2.1     |                   | pA/ $\sqrt{Hz}$ |
| <b>TRANSIENT RESPONSE</b>       |                                                                              |                                                                                                                             |                 |         |                   |                 |
| SR                              | Slew Rate                                                                    |                                                                                                                             | 30<br><b>25</b> | 50      |                   | V/ $\mu s$      |
| $t_{pd}$                        | Propagation Delay<br>10% $V_{IN}$ - 10% $V_{OUT}$                            | $A_V = 1$ , $V_{OUT} = 100mV_{P-P}$ , $R_F = 0\Omega$ , $C_L = 1.2pF$                                                       |                 | 1.0     |                   | ns              |
| $t_r$ , $t_f$ , Small<br>Signal | Rise Time, $t_r$ 10% to 90%                                                  | $A_V = +1$ , $V_{OUT} = 0.1V_{P-P}$ , $R_F = 0\Omega$ , $C_L = 1.2pF$                                                       |                 | 3.3     |                   | ns              |
|                                 | Fall Time, $t_f$ 10% to 90%                                                  |                                                                                                                             |                 | 6.3     |                   | ns              |
| $t_r$ , $t_f$ Large<br>Signal   | Rise Time, $t_r$ 10% to 90%                                                  | $A_V = +2$ , $V_{OUT} = 1V_{P-P}$ , $R_F = R_G = 499\Omega$ , $R_L = 10k\Omega$ ,<br>$C_L = 1.2pF$                          |                 | 44      |                   | ns              |
|                                 | Fall Time, $t_f$ 10% to 90%                                                  |                                                                                                                             |                 | 51      |                   | ns              |
|                                 | Rise Time, $t_r$ 10% to 90%                                                  | $A_V = +2$ , $V_{OUT} = 4.7V_{P-P}$ , $R_F = R_G = 499\Omega$ ,<br>$R_L = 10k\Omega$ , $C_L = 1.2pF$                        |                 | 190     |                   | ns              |
|                                 | Fall Time, $t_f$ 10% to 90%                                                  |                                                                                                                             |                 | 187     |                   | ns              |
| $t_s$                           | Settling Time to 0.1%<br>90% $V_{OUT}$ to 0.1% $V_{OUT}$                     | $A_V = 1$ , $V_{OUT} = 1V_{P-P}$ , $R_F = 0\Omega$ , $C_L = 1.2pF$                                                          |                 | 45      |                   | ns              |
| $t_{EN}$                        | ENABLE to Output Turn-on Delay<br>Time; 10% $\overline{EN}$ - 10% $V_{OUT}$  | $A_V = 1$ , $V_{OUT} = 1V_{DC}$ , $R_L = 10k\Omega$ , $C_L = 1.2pF$                                                         |                 | 330     |                   | ns              |
|                                 | ENABLE to Output Turn-off Delay<br>Time; 10% $\overline{EN}$ - 10% $V_{OUT}$ | $A_V = 1$ , $V_{OUT} = 0V_{DC}$ , $R_L = 10k\Omega$ , $C_L = 1.2pF$                                                         |                 | 50      |                   | ns              |

NOTE:

- Parameters with MIN and/or MAX limits are 100% tested at  $+25^\circ C$ , unless otherwise specified. Temperature limits established by characterization and are not production tested.

## Typical Performance Curves

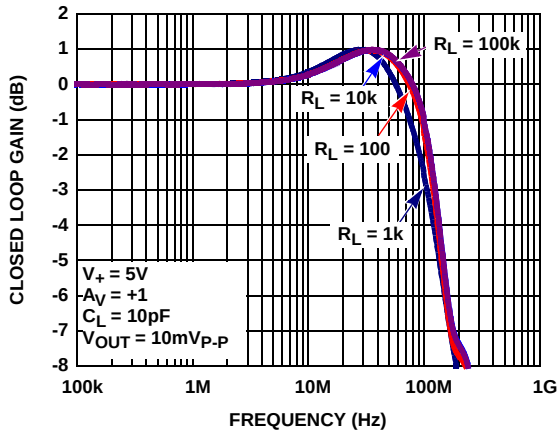


FIGURE 1. GAIN vs FREQUENCY FOR VARIOUS  $R_{LOAD}$

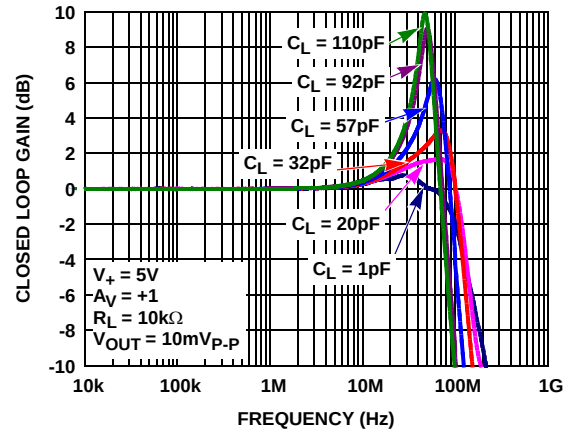


FIGURE 2. GAIN vs FREQUENCY FOR VARIOUS  $C_{LOAD}$

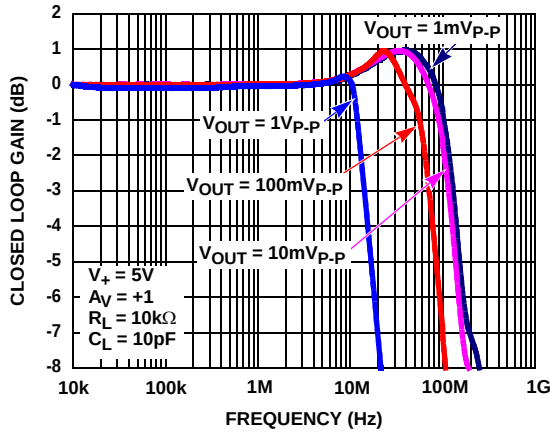


FIGURE 3. -3dB BANDWIDTH vs  $V_{OUT}$

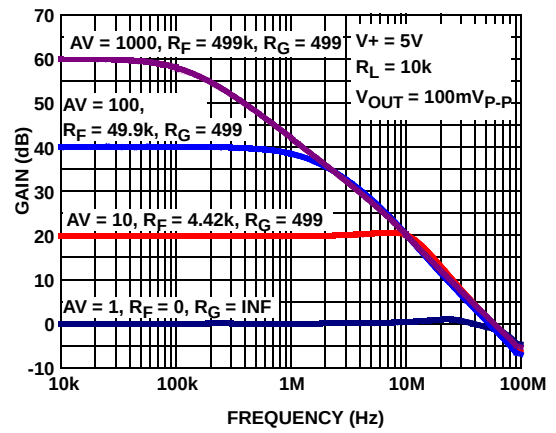


FIGURE 4. FREQUENCY RESPONSE vs CLOSED LOOP GAIN

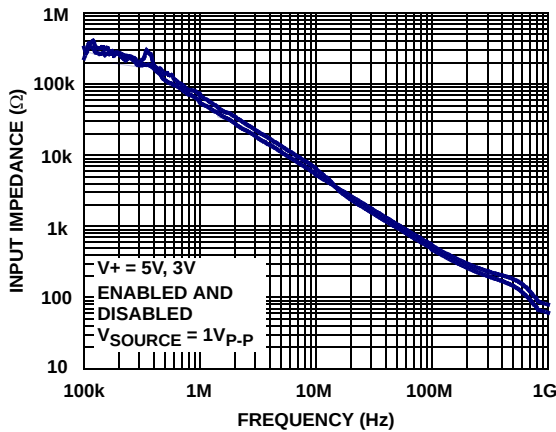


FIGURE 5. INPUT IMPEDANCE vs FREQUENCY

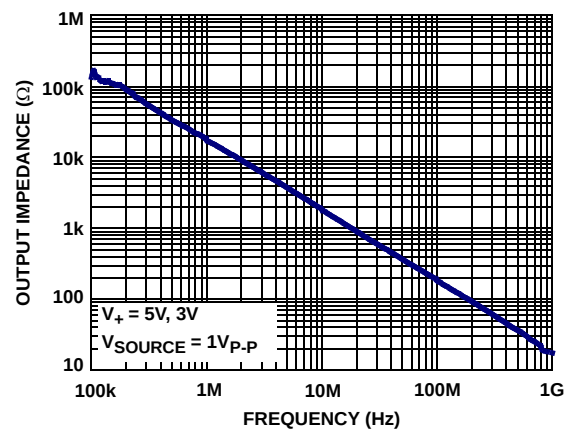


FIGURE 6. DISABLED OUTPUT IMPEDANCE vs FREQUENCY

Typical Performance Curves (Continued)

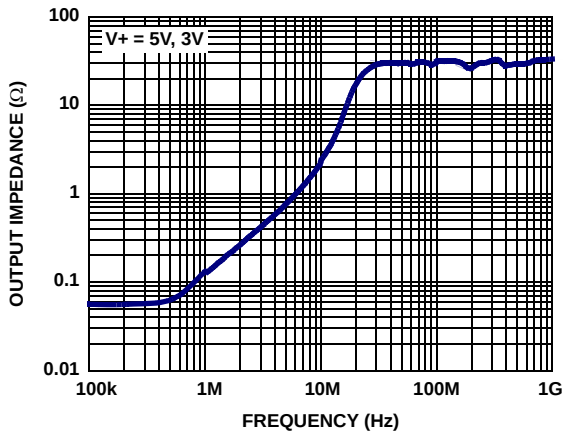


FIGURE 7. ENABLED OUTPUT IMPEDANCE vs FREQUENCY

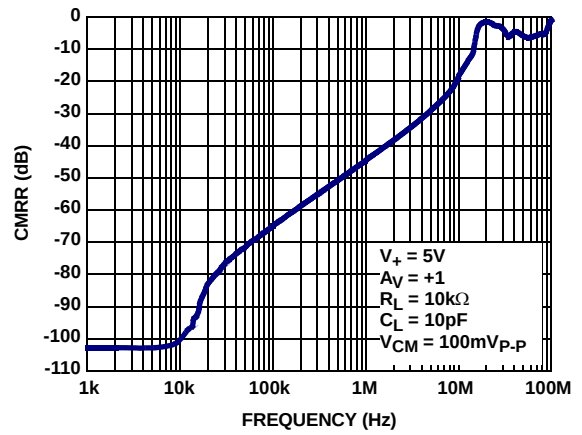


FIGURE 8. CMRR vs FREQUENCY

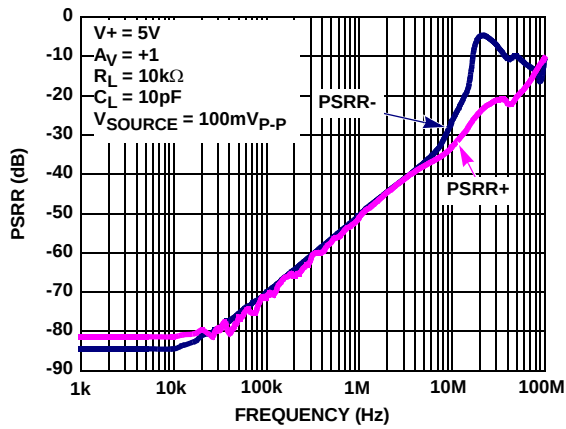


FIGURE 9. PSRR vs FREQUENCY

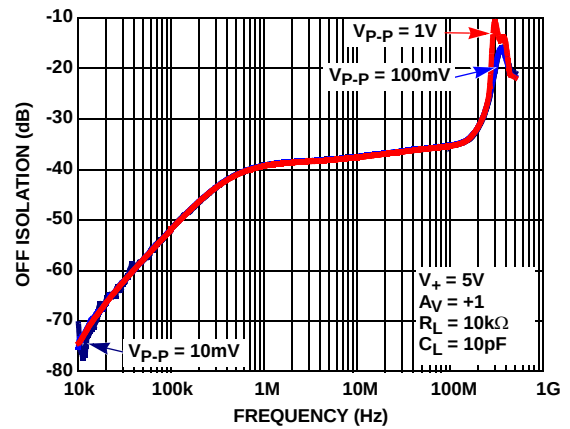


FIGURE 10. OFF ISOLATION vs FREQUENCY

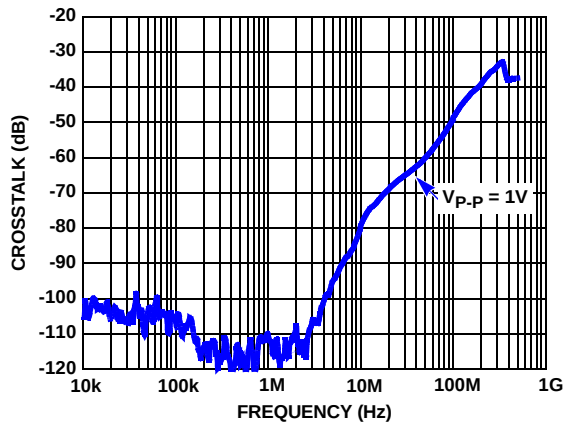


FIGURE 11. CHANNEL-TO-CHANNEL CROSSTALK vs FREQUENCY

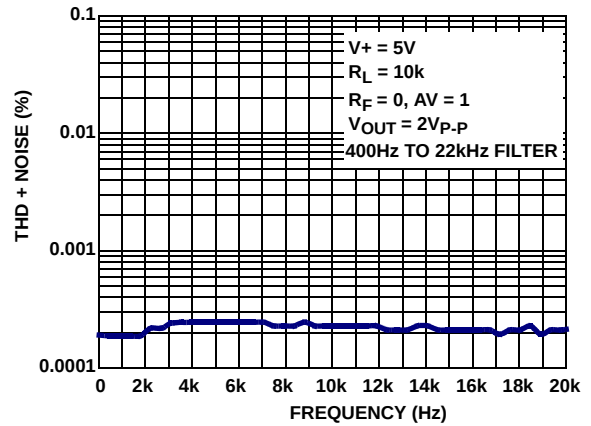


FIGURE 12. THD+N vs FREQUENCY

# Typical Performance Curves (Continued)

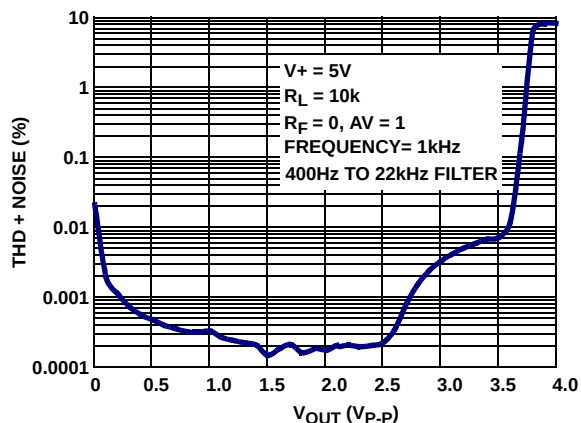


FIGURE 13. THD+N @ 1kHz vs  $V_{OUT}$

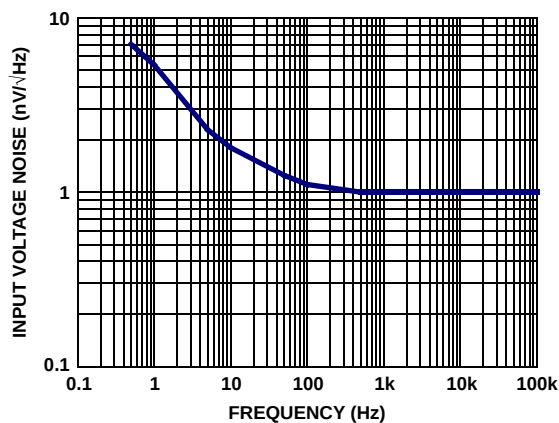


FIGURE 14. INPUT REFERRED NOISE VOLTAGE vs FREQUENCY

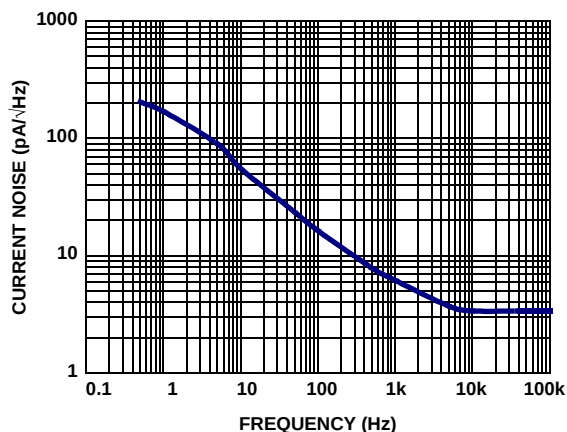


FIGURE 15. INPUT REFERRED NOISE CURRENT vs FREQUENCY

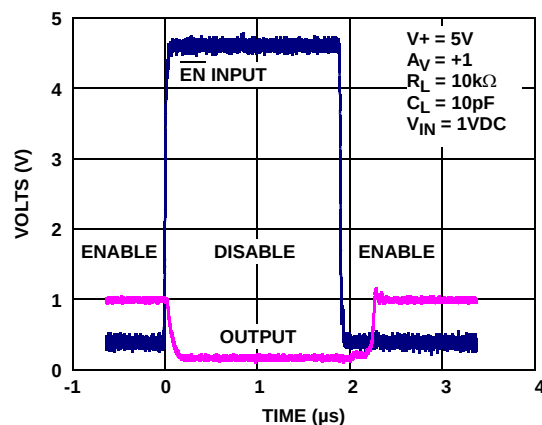


FIGURE 16. ENABLE/DISABLE TIMING

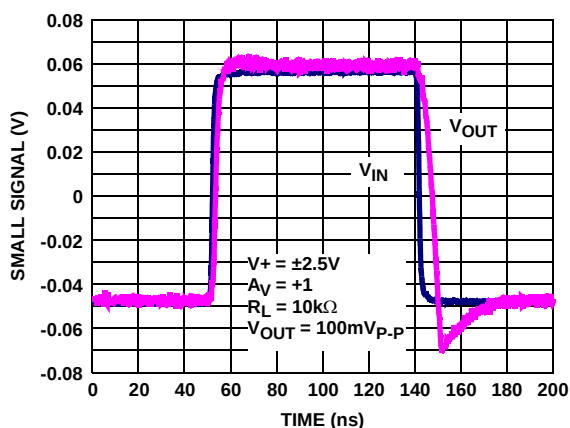


FIGURE 17. SMALL SIGNAL STEP RESPONSE

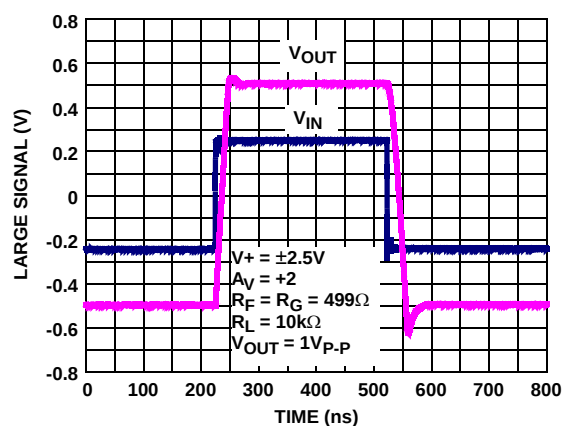


FIGURE 18. LARGE SIGNAL (1V) STEP RESPONSE

# Typical Performance Curves (Continued)

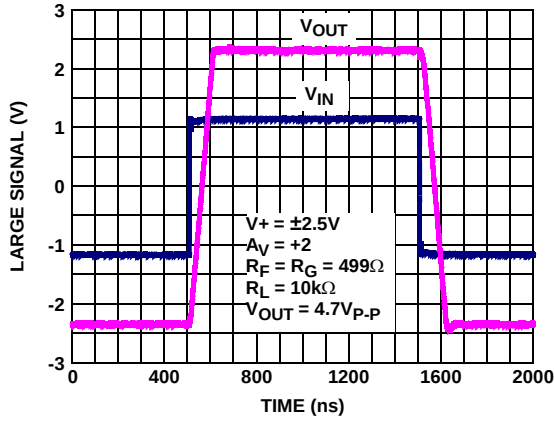


FIGURE 19. LARGE SIGNAL (4.7V) STEP RESPONSE

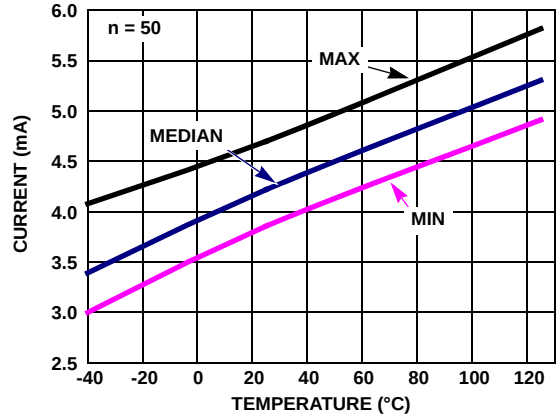


FIGURE 20. SUPPLY CURRENT vs TEMPERATURE,  $V_S = \pm 2.5V$  ENABLED,  $R_L = \text{INF}$

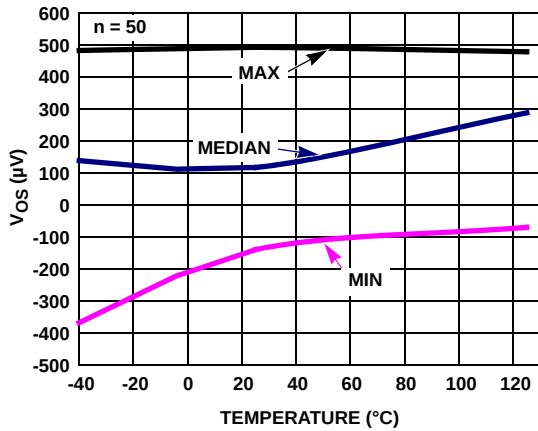


FIGURE 21.  $V_{OS}$  vs TEMPERATURE  $V_S = \pm 2.5V$

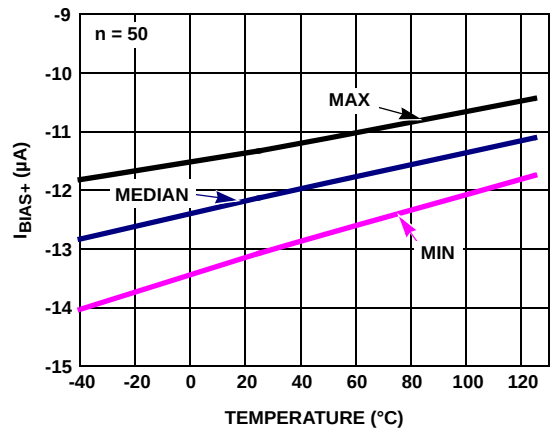


FIGURE 22.  $I_{BIAS+}$  vs TEMPERATURE  $V_S = \pm 2.5V$

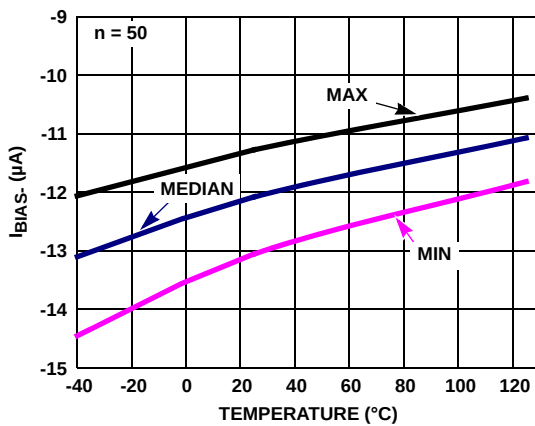


FIGURE 23.  $I_{BIAS-}$  vs TEMPERATURE  $V_S = \pm 2.5V$

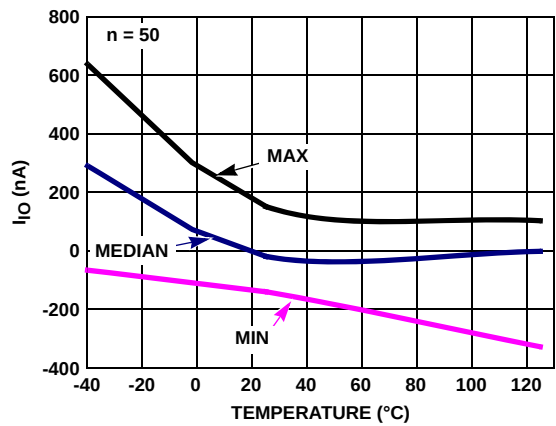


FIGURE 24.  $I_{IO}$  vs TEMPERATURE  $V_S = \pm 2.5V$

# Typical Performance Curves (Continued)

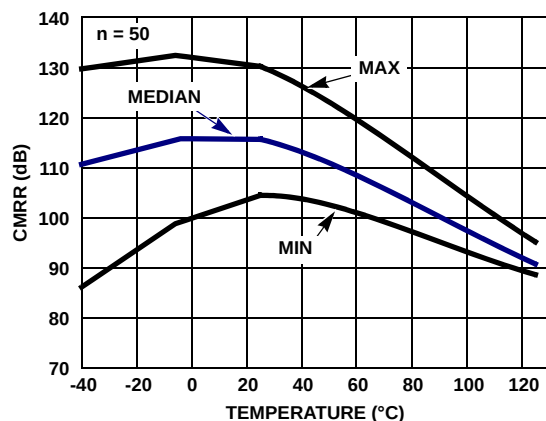


FIGURE 25. CMRR vs TEMPERATURE, VCM = 3.8V, VS = ±2.5V

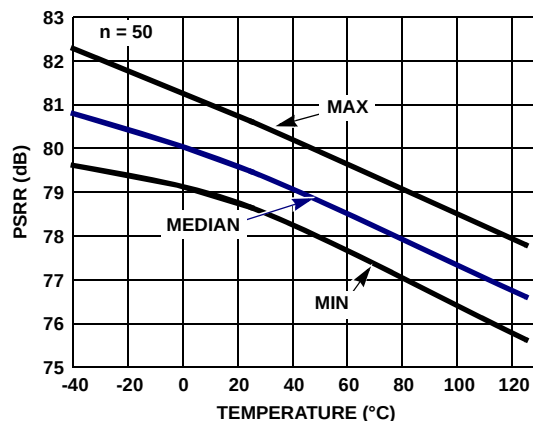


FIGURE 26. PSRR vs TEMPERATURE ±1.5V TO ±2.5V

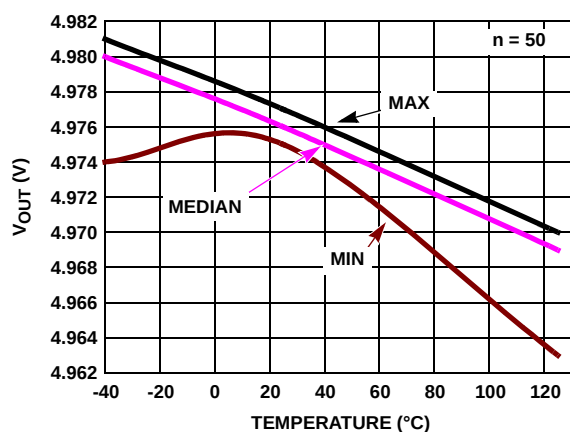


FIGURE 27. POSITIVE VOUT vs TEMPERATURE RL = 1k, VS = ±2.5V

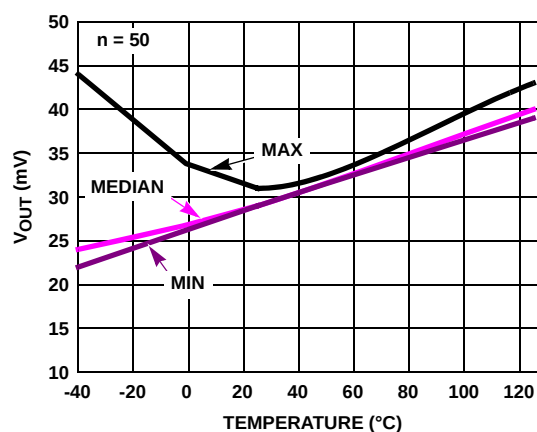
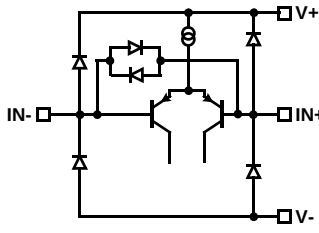
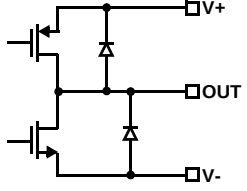
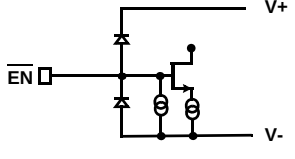


FIGURE 28. NEGATIVE VOUT vs TEMPERATURE RL = 1k, VS = ±2.5V

## Pin Descriptions

| ISL28190<br>(6 Ld SOT-23) | ISL28190<br>(6 Ld µTDFN) | ISL28290<br>(10 Ld MSOP) | ISL28290<br>(10 Ld µTQFN) | ISL28290<br>(8 Ld SOIC) | PIN<br>NAME           | FUNCTION            | EQUIVALENT<br>CIRCUIT                                                                                  |
|---------------------------|--------------------------|--------------------------|---------------------------|-------------------------|-----------------------|---------------------|--------------------------------------------------------------------------------------------------------|
| 4                         | 2                        | 2 (A)<br>8 (B)           | 1 (A)<br>7 (B)            | 2 (A)<br>6 (B)          | IN-<br>IN-_A<br>IN-_B | Inverting input     |  <p>Circuit 1</p> |
| 3                         | 3                        | 3 (A)<br>7 (B)           | 2 (A)<br>6 (B)            | 3 (A)<br>5 (B)          | IN+<br>IN+_A<br>IN+_B | Non-inverting input | (See Circuit 1)                                                                                        |
| 2                         | 4                        | 4                        | 3                         | 4                       | V-                    | Negative supply     |                                                                                                        |

## Pin Descriptions (Continued)

| ISL28190<br>(6 Ld SOT-23) | ISL28190<br>(6 Ld $\mu$ TDFN) | ISL28290<br>(10 Ld MSOP) | ISL28290<br>(10 Ld $\mu$ TQFN) | ISL28290<br>(8 Ld SOIC) | PIN<br>NAME                                                                    | FUNCTION                                                                                                                     | EQUIVALENT<br>CIRCUIT                                                                                |
|---------------------------|-------------------------------|--------------------------|--------------------------------|-------------------------|--------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------|
| 1                         | 1                             | 1 (A)<br>9 (B)           | 10 (A)<br>8 (B)                | 1 (A)<br>7 (B)          | OUT<br>OUT_A<br>OUT_B                                                          | Output                                                                                                                       |  <p>Circuit 2</p> |
| 6                         | 6                             | 10                       | 9                              | 8                       | V+                                                                             | Positive supply                                                                                                              |                                                                                                      |
| 5                         | 5                             | 5 (A)<br>6 (B)           | 4 (A)<br>5 (B)                 | N/A                     | $\overline{\text{EN}}$<br>$\overline{\text{EN}}_A$<br>$\overline{\text{EN}}_B$ | Enable BAR pin<br>internal pull-down;<br>Logic "1" selects<br>the disabled state;<br>Logic "0" selects<br>the enabled state. |  <p>Circuit 3</p> |

## Applications Information

### Product Description

The ISL28190 and ISL28290 are voltage feedback operational amplifiers designed for communication and imaging applications requiring low distortion, very low voltage and current noise. Both parts feature high bandwidth while drawing moderately low supply current. The ISL28190 and ISL28290 use a classical voltage-feedback topology, which allows them to be used in a variety of applications where current-feedback amplifiers are not appropriate because of restrictions placed upon the feedback element used with the amplifier.

### Enable/Power-Down

The ISL28190 and ISL28290 amplifiers are disabled by applying a voltage greater than 2V to the  $\overline{\text{EN}}$  pin, with respect to the V- pin. In this condition, the output(s) will be in a high impedance state and the amplifier(s) current will be reduced to 13 $\mu$ A/Amp. By disabling the part, multiple parts can be connected together as a MUX. The outputs are tied together in parallel and a channel can be selected by the  $\overline{\text{EN}}$  pin. The  $\overline{\text{EN}}$  pin also has an internal pull-down. If left open, the  $\overline{\text{EN}}$  pin will pull to the negative rail and the device will be enabled by default.

### Input Protection

All input terminals have internal ESD protection diodes to both positive and negative supply rails, limiting the input voltage to within one diode beyond the supply rails. Both parts have additional back-to-back diodes across the input terminals (as shown in Figure 29). In pulse applications where the input Slew Rate exceeds the Slew Rate of the amplifier, the possibility exists for the input protection diodes to become forward biased. This can cause excessive input current and distortion at the outputs. If overdriving the inputs is necessary, the external input current must never exceed 5mA. An

external series resistor may be used to limit the current, as shown in Figure 29.

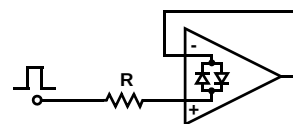


FIGURE 29. LIMITING THE INPUT CURRENT TO LESS THAN 5mA

### Using Only One Channel

The ISL28290 is a Dual channel op amp. If the application only requires one channel when using the ISL28290, the user must configure the unused channel to prevent it from oscillating. Oscillation can occur if the input and output pins are floating. This will result in higher than expected supply currents and possible noise injection into the channel being used. The proper way to prevent this oscillation is to short the output to the negative input and ground the positive input (as shown in Figure 30).

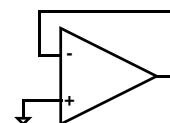


FIGURE 30. PREVENTING OSCILLATIONS IN UNUSED CHANNELS

### Power Supply Bypassing and Printed Circuit Board Layout

As with any high frequency device, good printed circuit board layout is necessary for optimum performance. Low impedance ground plane construction is essential. Surface mount components are recommended, but if leaded components are used, lead lengths should be as short as possible. The power supply pins must be well bypassed to

reduce the risk of oscillation. The combination of a 4.7μF tantalum capacitor in parallel with a 0.01μF capacitor has been shown to work well when placed at each supply pin.

For good AC performance, parasitic capacitance should be kept to a minimum, especially at the inverting input. When ground plane construction is used, it should be removed from the area near the inverting input to minimize any stray capacitance at that node. Carbon or Metal-Film resistors are acceptable with the Metal-Film resistors giving slightly less peaking and bandwidth because of additional series inductance. Use of sockets, particularly for the SO package, should be avoided if possible. Sockets add parasitic inductance and capacitance, which will result in additional peaking and overshoot.

### Current Limiting

The ISL28190 and ISL28290 have no internal current-limiting circuitry. If the output is shorted, it is possible to exceed the Absolute Maximum Rating for output current or power dissipation, potentially resulting in the destruction of the device. This is why output short circuit current is specified and tested with  $R_L = 10\Omega$ .

### Power Dissipation

It is possible to exceed the +125°C maximum junction temperatures under certain load and power-supply conditions. It is therefore important to calculate the maximum junction temperature ( $T_{JMAX}$ ) for all applications to determine if power supply voltages, load conditions, or package type need to be modified to remain in the safe operating area. These parameters are related as follows:

$$T_{JMAX} = T_{MAX} + (\theta_{JA} \times PD_{MAXTOTAL}) \quad (EQ. 1)$$

where:

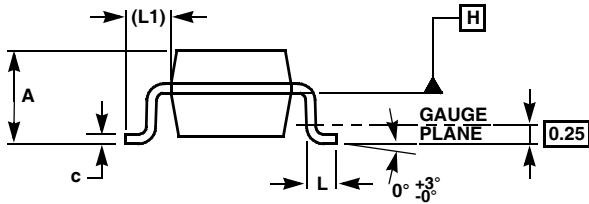
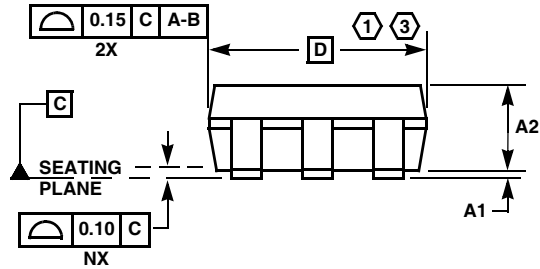
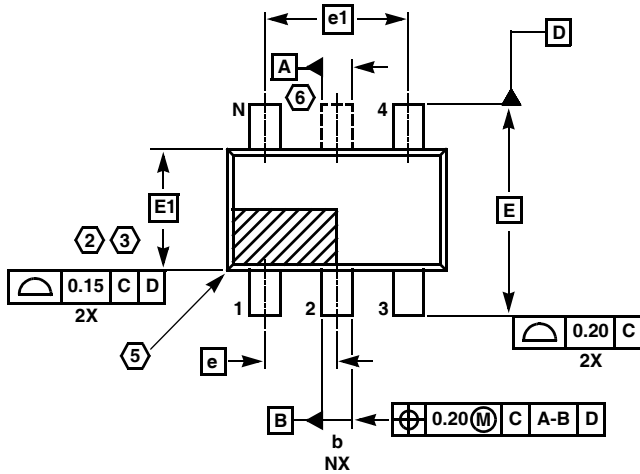
- $PD_{MAXTOTAL}$  is the sum of the maximum power dissipation of each amplifier in the package ( $PD_{MAX}$ )
- $PD_{MAX}$  for each amplifier can be calculated as follows:

$$PD_{MAX} = 2 \times V_S \times I_{SMAX} + (V_S - V_{OUTMAX}) \times \frac{V_{OUTMAX}}{R_L} \quad (EQ. 2)$$

where  $T_{MAX}$  = Maximum ambient temperature

- $\theta_{JA}$  = Thermal resistance of the package
- $PD_{MAX}$  = Maximum power dissipation of 1 amplifier
- $V_S$  = Supply voltage
- $I_{MAX}$  = Maximum supply current of 1 amplifier
- $V_{OUTMAX}$  = Maximum output voltage swing of the application
- $R_L$  = Load resistance

# SOT-23 Package Family



## MDP0038

### SOT-23 PACKAGE FAMILY

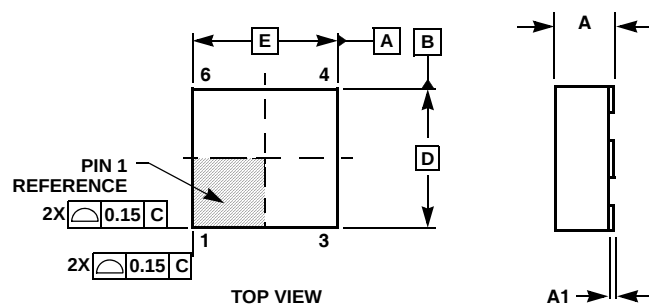
| SYMBOL | MILLIMETERS |         | TOLERANCE |
|--------|-------------|---------|-----------|
|        | SOT23-5     | SOT23-6 |           |
| A      | 1.45        | 1.45    | MAX       |
| A1     | 0.10        | 0.10    | ±0.05     |
| A2     | 1.14        | 1.14    | ±0.15     |
| b      | 0.40        | 0.40    | ±0.05     |
| c      | 0.14        | 0.14    | ±0.06     |
| D      | 2.90        | 2.90    | Basic     |
| E      | 2.80        | 2.80    | Basic     |
| E1     | 1.60        | 1.60    | Basic     |
| e      | 0.95        | 0.95    | Basic     |
| e1     | 1.90        | 1.90    | Basic     |
| L      | 0.45        | 0.45    | ±0.10     |
| L1     | 0.60        | 0.60    | Reference |
| N      | 5           | 6       | Reference |

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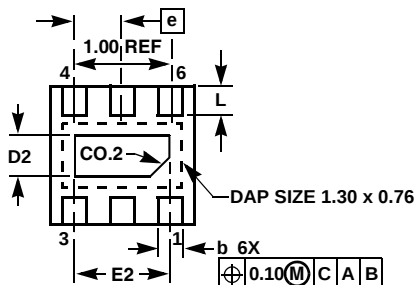
#### NOTES:

1. Plastic or metal protrusions of 0.25mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25mm maximum per side are not included.
3. This dimension is measured at Datum Plane "H".
4. Dimensioning and tolerancing per ASME Y14.5M-1994.
5. Index area - Pin #1 I.D. will be located within the indicated zone (SOT23-6 only).
6. SOT23-5 version has no center lead (shown as a dashed line).

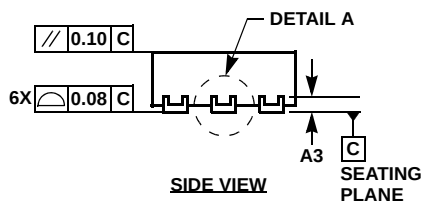
# Ultra Thin Dual Flat No-Lead Plastic Package (UTDFN)



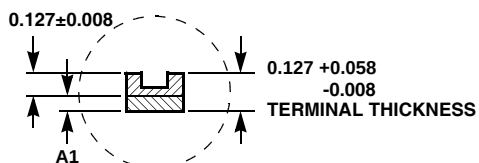
TOP VIEW



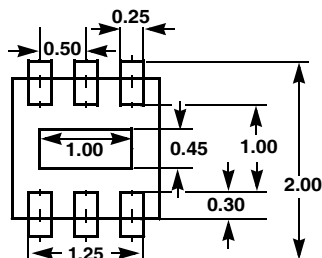
BOTTOM VIEW



SIDE VIEW



DETAIL A



LAND PATTERN 6

## L6.1.6x1.6A

### 6 LEAD ULTRA THIN DUAL FLAT NO-LEAD PLASTIC PACKAGE

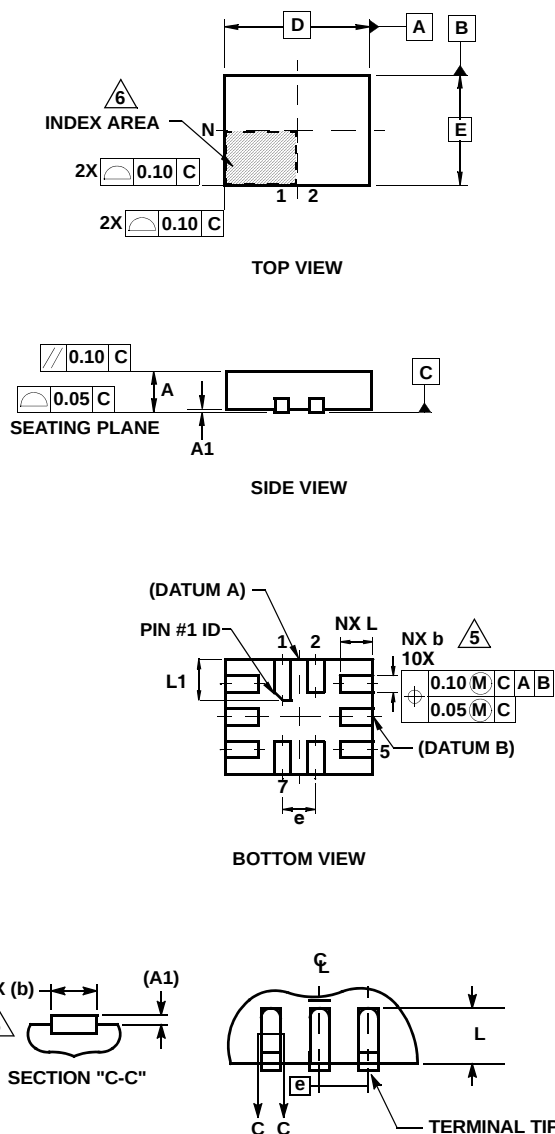
| SYMBOL | MILLIMETERS |         |      | NOTES |
|--------|-------------|---------|------|-------|
|        | MIN         | NOMINAL | MAX  |       |
| A      | 0.45        | 0.50    | 0.55 | -     |
| A1     | -           | -       | 0.05 | -     |
| A3     | 0.127 REF   |         |      | -     |
| b      | 0.15        | 0.20    | 0.25 | -     |
| D      | 1.55        | 1.60    | 1.65 | 4     |
| D2     | 0.40        | 0.45    | 0.50 | -     |
| E      | 1.55        | 1.60    | 1.65 | 4     |
| E2     | 0.95        | 1.00    | 1.05 | -     |
| e      | 0.50 BSC    |         |      | -     |
| L      | 0.25        | 0.30    | 0.35 | -     |

Rev. 1 6/06

#### NOTES:

1. Dimensions are in mm. Angles in degrees.
2. Coplanarity applies to the exposed pad as well as the terminals. Coplanarity shall not exceed 0.08mm.
3. Warpage shall not exceed 0.10mm.
4. Package length/package width are considered as special characteristics.
5. JEDEC Reference MO-229.
6. For additional information, to assist with the PCB Land Pattern Design effort, see Intersil Technical Brief TB389.

# Ultra Thin Quad Flat No-Lead Plastic Package (UTQFN)



## L10.1.8x1.4A

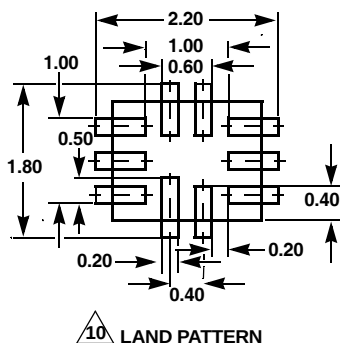
### 10 LEAD ULTRA THIN QUAD FLAT NO-LEAD PLASTIC PACKAGE

| SYMBOL | MILLIMETERS |         |      | NOTES |
|--------|-------------|---------|------|-------|
|        | MIN         | NOMINAL | MAX  |       |
| A      | 0.45        | 0.50    | 0.55 | -     |
| A1     | -           | -       | 0.05 | -     |
| A3     | 0.127 REF   |         |      | -     |
| b      | 0.15        | 0.20    | 0.25 | 5     |
| D      | 1.75        | 1.80    | 1.85 | -     |
| E      | 1.35        | 1.40    | 1.45 | -     |
| e      | 0.40 BSC    |         |      | -     |
| L      | 0.35        | 0.40    | 0.45 | -     |
| L1     | 0.45        | 0.50    | 0.55 | -     |
| N      | 10          |         |      | 2     |
| Nd     | 2           |         |      | 3     |
| Ne     | 3           |         |      | 3     |
| θ      | 0           | -       | 12   | 4     |

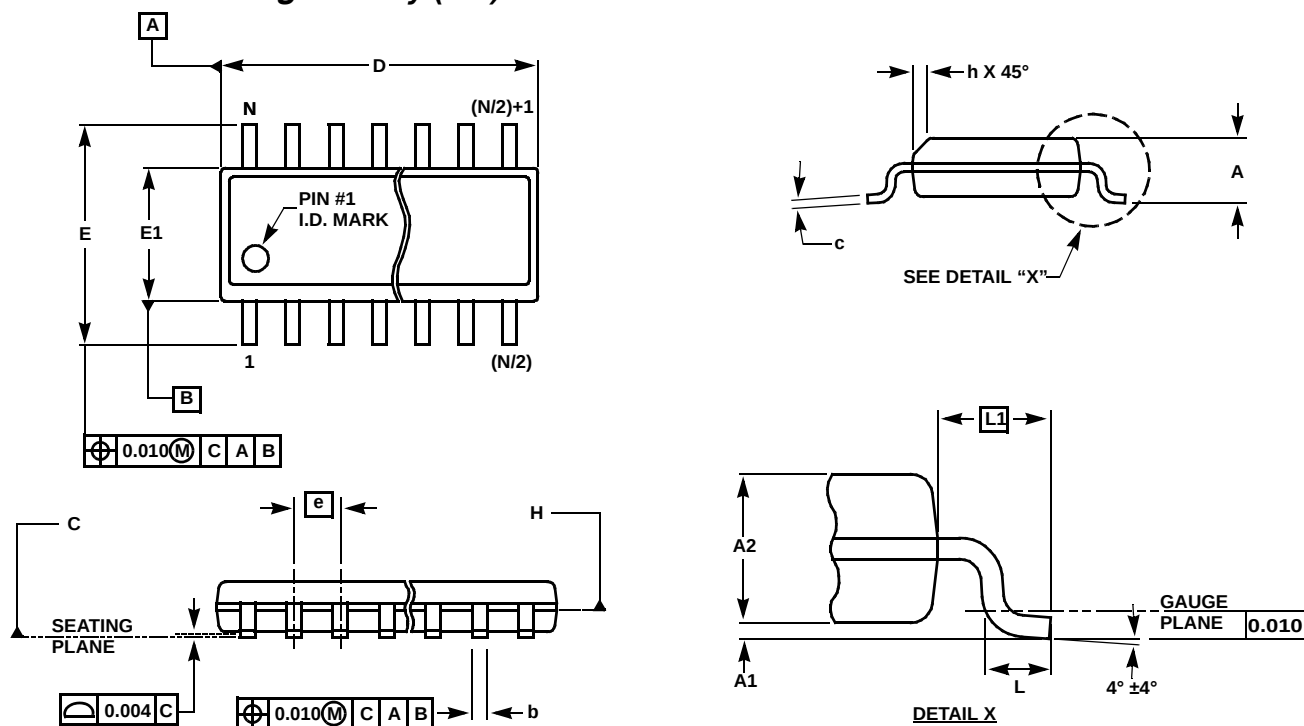
Rev. 3 6/06

#### NOTES:

1. Dimensioning and tolerancing conform to ASME Y14.5-1994.
2. N is the number of terminals.
3. Nd and Ne refer to the number of terminals on D and E side, respectively.
4. All dimensions are in millimeters. Angles are in degrees.
5. Dimension b applies to the metallized terminal and is measured between 0.15mm and 0.30mm from the terminal tip.
6. The configuration of the pin #1 identifier is optional, but must be located within the zone indicated. The pin #1 identifier may be either a mold or mark feature.
7. Maximum package warpage is 0.05mm.
8. Maximum allowable burrs is 0.076mm in all directions.
9. JEDEC Reference MO-255.
10. For additional information, to assist with the PCB Land Pattern Design effort, see Intersil Technical Brief TB389.



# Small Outline Package Family (SO)



## MDP0027

### SMALL OUTLINE PACKAGE FAMILY (SO)

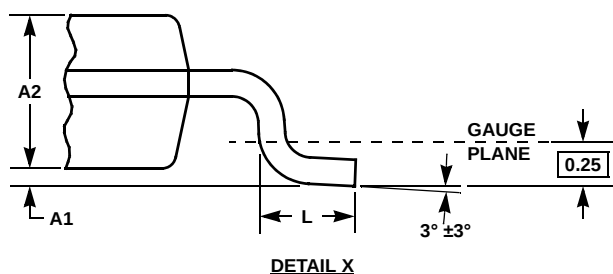
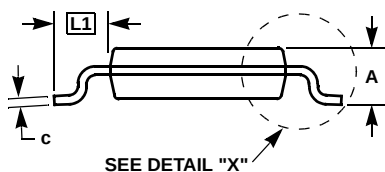
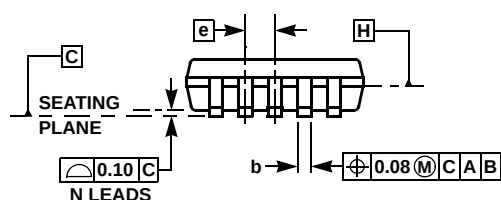
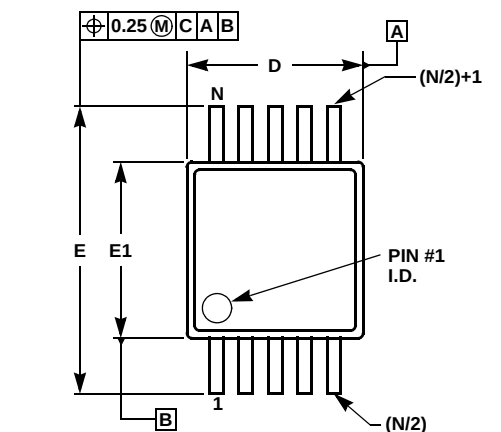
| SYMBOL | INCHES |       |                  |                           |                  |                  |                  | TOLERANCE | NOTES |
|--------|--------|-------|------------------|---------------------------|------------------|------------------|------------------|-----------|-------|
|        | SO-8   | SO-14 | SO16<br>(0.150") | SO16 (0.300")<br>(SOL-16) | SO20<br>(SOL-20) | SO24<br>(SOL-24) | SO28<br>(SOL-28) |           |       |
| A      | 0.068  | 0.068 | 0.068            | 0.104                     | 0.104            | 0.104            | 0.104            | MAX       | -     |
| A1     | 0.006  | 0.006 | 0.006            | 0.007                     | 0.007            | 0.007            | 0.007            | ±0.003    | -     |
| A2     | 0.057  | 0.057 | 0.057            | 0.092                     | 0.092            | 0.092            | 0.092            | ±0.002    | -     |
| b      | 0.017  | 0.017 | 0.017            | 0.017                     | 0.017            | 0.017            | 0.017            | ±0.003    | -     |
| c      | 0.009  | 0.009 | 0.009            | 0.011                     | 0.011            | 0.011            | 0.011            | ±0.001    | -     |
| D      | 0.193  | 0.341 | 0.390            | 0.406                     | 0.504            | 0.606            | 0.704            | ±0.004    | 1, 3  |
| E      | 0.236  | 0.236 | 0.236            | 0.406                     | 0.406            | 0.406            | 0.406            | ±0.008    | -     |
| E1     | 0.154  | 0.154 | 0.154            | 0.295                     | 0.295            | 0.295            | 0.295            | ±0.004    | 2, 3  |
| e      | 0.050  | 0.050 | 0.050            | 0.050                     | 0.050            | 0.050            | 0.050            | Basic     | -     |
| L      | 0.025  | 0.025 | 0.025            | 0.030                     | 0.030            | 0.030            | 0.030            | ±0.009    | -     |
| L1     | 0.041  | 0.041 | 0.041            | 0.056                     | 0.056            | 0.056            | 0.056            | Basic     | -     |
| h      | 0.013  | 0.013 | 0.013            | 0.020                     | 0.020            | 0.020            | 0.020            | Reference | -     |
| N      | 8      | 14    | 16               | 16                        | 20               | 24               | 28               | Reference | -     |

Rev. M 2/07

#### NOTES:

1. Plastic or metal protrusions of 0.006" maximum per side are not included.
2. Plastic interlead protrusions of 0.010" maximum per side are not included.
3. Dimensions "D" and "E1" are measured at Datum Plane "H".
4. Dimensioning and tolerancing per ASME Y14.5M-1994

## Mini SO Package Family (MSOP)



## MDP0043

## MINI SO PACKAGE FAMILY

| SYMBOL | MILLIMETERS |        | TOLERANCE   | NOTES |
|--------|-------------|--------|-------------|-------|
|        | MSOP8       | MSOP10 |             |       |
| A      | 1.10        | 1.10   | Max.        | -     |
| A1     | 0.10        | 0.10   | ±0.05       | -     |
| A2     | 0.86        | 0.86   | ±0.09       | -     |
| b      | 0.33        | 0.23   | +0.07/-0.08 | -     |
| c      | 0.18        | 0.18   | ±0.05       | -     |
| D      | 3.00        | 3.00   | ±0.10       | 1, 3  |
| E      | 4.90        | 4.90   | ±0.15       | -     |
| E1     | 3.00        | 3.00   | ±0.10       | 2, 3  |
| e      | 0.65        | 0.50   | Basic       | -     |
| L      | 0.55        | 0.55   | ±0.15       | -     |
| L1     | 0.95        | 0.95   | Basic       | -     |
| N      | 8           | 10     | Reference   | -     |

Rev. D 2/07

## NOTES:

1. Plastic or metal protrusions of 0.15mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25mm maximum per side are not included.
3. Dimensions "D" and "E1" are measured at Datum Plane "H".
4. Dimensioning and tolerancing per ASME Y14.5M-1994.

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